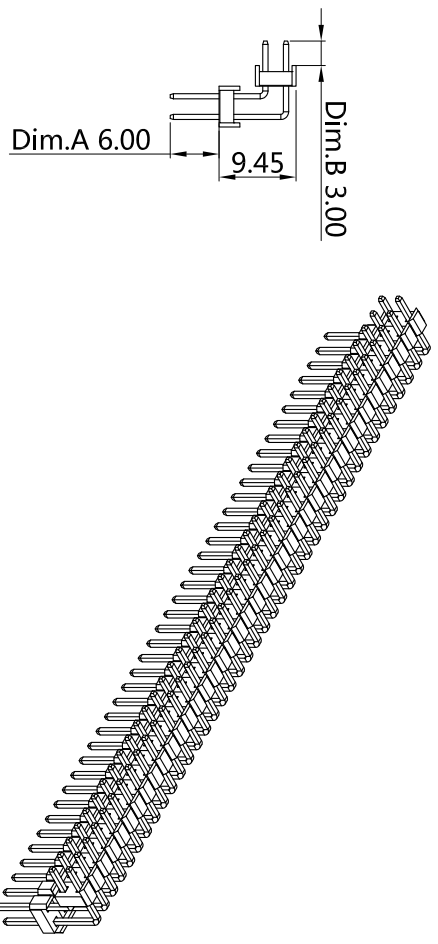
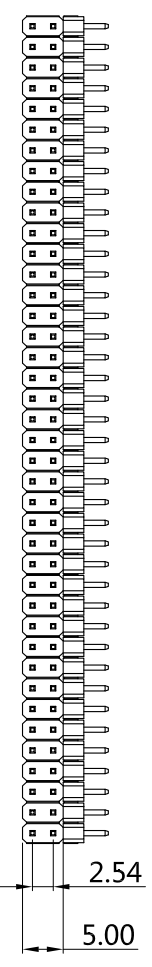
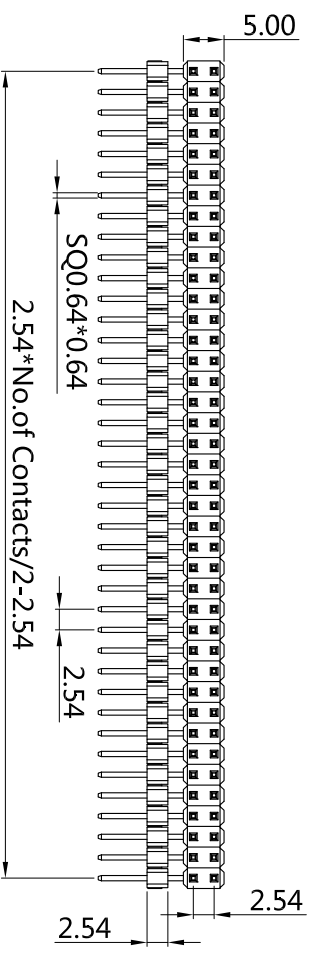
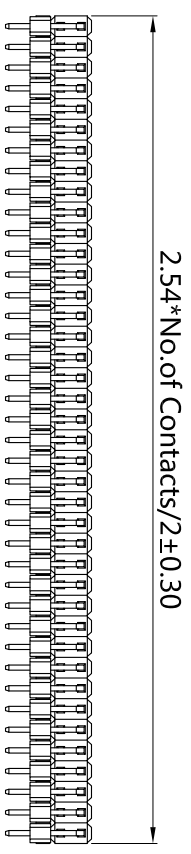
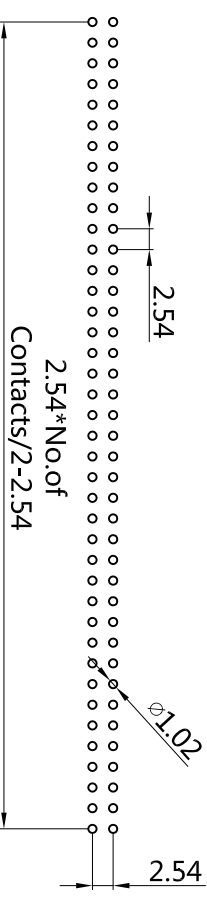


1	2	3	4	5	6	7	8
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Current Rating: 3 Amps
Insulator Resistance: 1000 Megohms min
Dielectric Withstanding: AC 500V
Contact Resistance: 20mΩ MAX
Operation Temperature: -40~+105°C
Max processing temp: 230°C for 60seconds
Max processing temp: 260°C for 10seconds
Contact Material: Brass
Insulator material: Standard: Polyester, UL 94V-0
Standard: PA6T
Finish: Tin Gold Plated
Standard: Tin Gold Flash all over

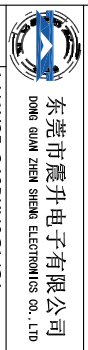
Recommended P.C. Board
SMD Layout



H1 X 25 - 2 XX R0 BK X D31 X

1. Insulator material:
2. Circuits:
3. Tail Style:
4. Color:
5. Contact Plated:
6. Special Options
7. Packing:

A=PBT N=PA6T
 L=LCP P=PA9T
 2. Circuits:2-40 PIN
 3. Tail Style:
 R0=90°
 BK=Black
 T=Matte Tin over Nickel
 W=Matte Tin over nickel 150μ"
 Y=Bright Tin over Nickel
 F=Gold Flash, Matte Tin 100μ"
 A=Gold 3μ"
 B=Gold 3μ", Matte Tin 100μ"
 C = ordinary gold plating
 D= Gold 5μ"
 I= Gold 1μ"
 E=Gold 5μ", Matte Tin 100μ"
 G=Gold 10μ"
 J=Gold 10μ", Matte Tin 100μ"
 L= Gold 15μ"
 M=Gold 15μ", Matte Tin 100μ"
 U= Gold 30μ"
 V=Gold 30μ", Matte Tin 100μ"
 A=Bag
 B=Tube
 C=Tray
 E=Cap+Reel



东莞市震升电子有限公司
DONG GUAN ZHEN SHENG ELECTRONICS CO., LTD

BOM	1:HX25-240BKHC1/C4	PART NO.	H1X25-2XXR0BKXD31X	X	.XX	.XXX
3:	2:SQ064-18.1/23.1-X-C12	DRAWING NO	ZS-10167-P	±0.30	±0.20	±0.1
		DRAWN BY	Deng jin quan	EDITION:A1	2022-5-25	SCALE:1:1
		APPROVAL BY	Chen xiao guang	2022-5-25		UNIT:M:M

1	2	3	4	5	6	7	8
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